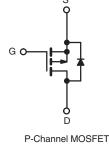
### **Vishay Siliconix**

## Power MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	- 100			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = - 10 V	1.2		
Q <sub>g</sub> (Max.) (nC)	8.7			
Q <sub>gs</sub> (nC)	2.2			
Q <sub>gd</sub> (nC)	4.1			
Configuration	Single			





### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- 175 °C Operating Temperature
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D<sup>2</sup>PAK (TO-263) is a surface mount power package capable of accommodating die size up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D<sup>2</sup>PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

ORDERING INFORMATION				
Package	D <sup>2</sup> PAK (TO-263)	D <sup>2</sup> PAK (TO-263)		
Lead (Pb)-free and Halogen-free	SiHF9510S-GE3	SiHF9510STRL-GE3ª		
Lead (Pb)-free	IRF9510SPbF	IRF9510STRLPbF <sup>a</sup>		
	SiHF9510S-E3	SiHF9510STL-E3ª		
SnPb	IRF9510S	IRF9510STRL <sup>a</sup>		
	SiHF9510S	SiHF9510STL <sup>a</sup>		

Note

a. See device orientation.

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	- 100	V	
Gate-Source Voltage			V <sub>GS</sub>	± 20		
Continuous Drain Current	Vec at - 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	L	- 4.0	А	
	VGS at - 10 V		I <sub>D</sub>	- 2.8		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	- 16		
Linear Derating Factor				0.29	W/°C	
Linear Derating Factor (PCB Mount) <sup>e</sup>				0.025		
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	200	mJ	
Avalanche Current <sup>a</sup>			I <sub>AR</sub>	- 4.0	А	
Repetiitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	4.3	mJ	
Maximum Power Dissipation	$T_{\rm C} = 1$	25 °C	D	43	W	
Maximum Power Dissipation (PCB Mount)e	$T_A = 2$	25 °C	P <sub>D</sub> –	3.7		
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	- 5.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature) for 10 s			-	300 <sup>d</sup>		

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b.  $V_{DD} = -25$  V, starting  $T_J = 25$  °C, L = 18 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = -4.0$  A (see fig. 12). c.  $I_{SD} \le -4.0$  A, dI/dt  $\le 75$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C. d. 1.6 mm from case.

When mounted on 1" square PCB (FR-4 or G-10 material).

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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COMPLIANT

HALOGEN

FREE

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62		
Maximum Junction-to-Ambient (PCB Mount) <sup>a</sup>	R <sub>thJA</sub>	-	40	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	3.5		

#### Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$		- 100	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I <sub>D</sub> = - 1 mA		- 0.091	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$		-	- 4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
		V <sub>DS</sub> =	$V_{DS} = -100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	- 100	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 80 V	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	- 500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V	I <sub>D</sub> = - 2.4 A <sup>b</sup>	-	-	1.2	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = ·	- 50 V, I <sub>D</sub> = - 2.4 A <sup>b</sup>	1.0	-	-	S
Dynamic		•					<b>I</b>
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = - 25 V, f = 1.0 MHz, see fig. 5		-	200	-	pF
Output Capacitance	Coss			-	94	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	18	-	
Total Gate Charge	Qg		$V_{GS} = -10 \text{ V}$ $I_D = -4.0 \text{ A}, V_{DS} = -80 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	8.7	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V		-	-	2.2	
Gate-Drain Charge	Q <sub>gd</sub>			-	-	4.1	
Turn-On Delay Time	t <sub>d(on)</sub>				10	-	- ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 50 V, I <sub>D</sub> = - 4.0 A, R <sub>g</sub> = 24 $\Omega$ , R <sub>D</sub> = 11 $\Omega$ , see fig. 10 <sup>b</sup>		-	27	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	15	-	
Fall Time	t <sub>f</sub>			-	17	-	
Internal Drain Inductance	L <sub>D</sub>		Between lead, 6 mm (0.25") from		4.5	-	ᆔ
Internal Source Inductance	L <sub>S</sub>	package and center of		-	7.5	-	nH
Drain-Source Body Diode Characteristic	S						
Continuous Source-Drain Diode Current	I <sub>S</sub>	showing the	9 /// //		-	- 4.0	A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	p - n junction diode		-	-	- 16	
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C,	$I_{S}$ = - 4.0 A, $V_{GS}$ = 0 $V^{b}$	-	-	- 5.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- $T_J = 25 \text{ °C}, I_F = -4.0 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}^b$		-	82	160	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.15	0.30	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	on is dor	ninated b	v Ls and	L <sub>D</sub> )	

### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



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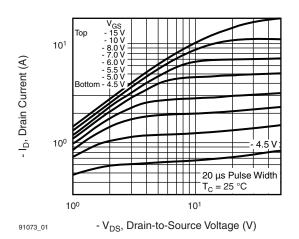


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

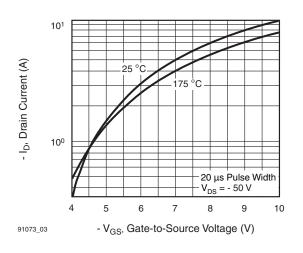


Fig. 3 - Typical Transfer Characteristics

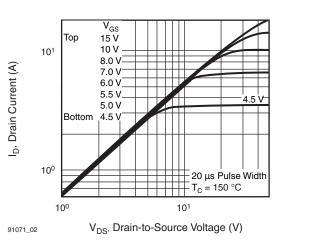


Fig. 2 - Typical Output Characteristics,  $T_C$  = 175 °C

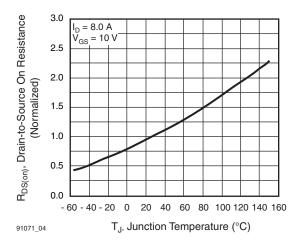


Fig. 4 - Normalized On-Resistance vs. Temperature

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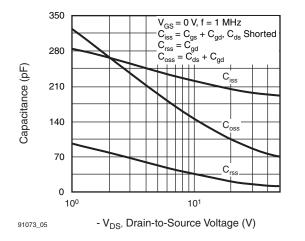


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

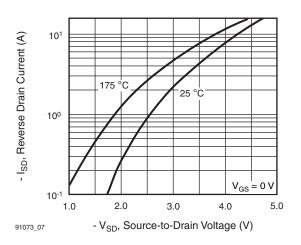


Fig. 7 - Typical Source-Drain Diode Forward Voltage

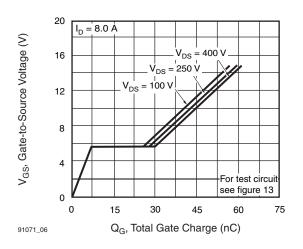


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

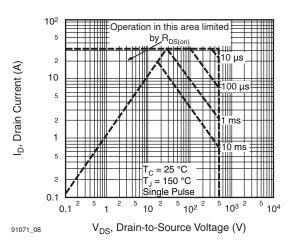


Fig. 8 - Maximum Safe Operating Area



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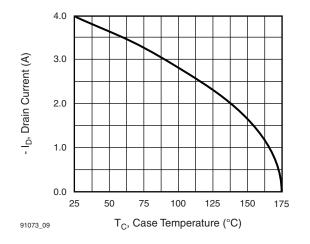


Fig. 9 - Maximum Drain Current vs. Case Temperature

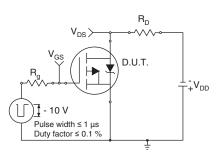


Fig. 10a - Switching Time Test Circuit

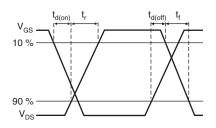


Fig. 10b - Switching Time Waveforms

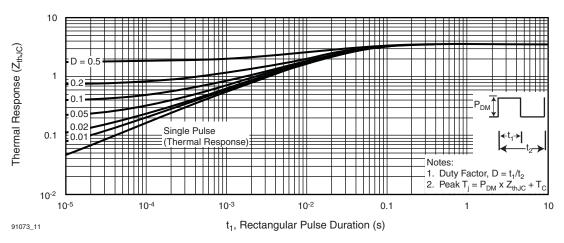
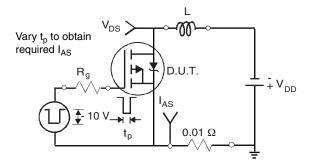
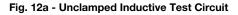
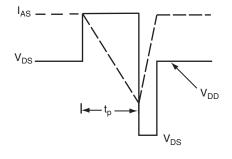


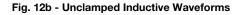
Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case





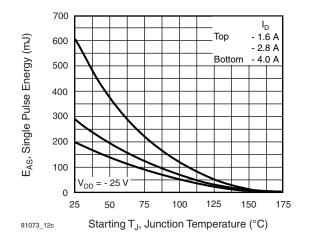
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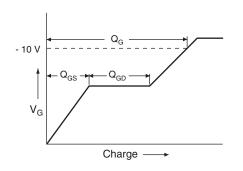


Fig. 13a - Basic Gate Charge Waveform

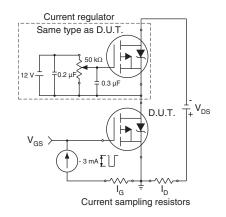
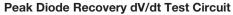


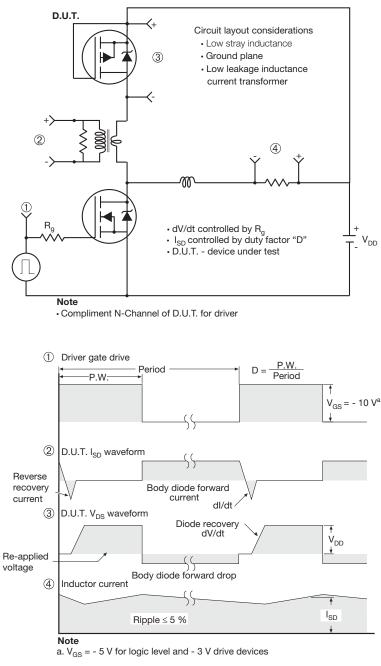
Fig. 13b - Gate Charge Test Circuit



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### Fig. 14 - For P-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg291073">www.vishay.com/ppg291073</a>.

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